# 3.3V ECL 4-Input OR/NOR

## Description

The MC100LVEL01 is a 4-input OR/NOR gate. The device is functionally equivalent to the EL01 device and works from a 3.3 V supply. With AC performance similar to the EL01 device, the LVEL01 is ideal for low voltage applications which require the ultimate in AC performance.

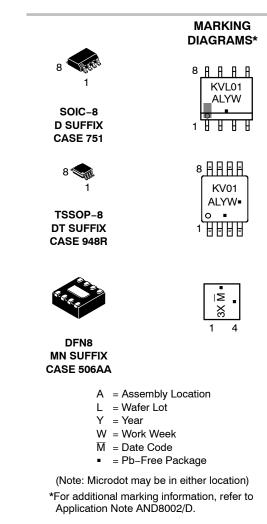
## Features

- 370 ps Propagation Delay
- High Bandwidth Output Transitions
- ESD Protection: >2 kV Human Body Model, >200 V Machine Model
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range:  $V_{CC} = 3.0 \text{ V}$  to 3.8 V with  $V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range:  $V_{CC} = 0 V$ with  $V_{EE} = -3.0 V$  to -3.8 V
- Internal Input Pulldown Resistors
- Q Output will Default LOW with All Inputs Open or at  $V_{\mbox{\scriptsize EE}}$
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1 For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL 94 V-0 @ 0.125 in, Oxygen Index 28 to 34
- Transistor Count = 83 devices
- Pb-Free Packages are Available



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## **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

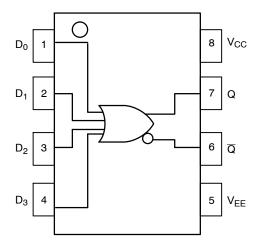


Figure 1. Logic Diagram and Pinout Assignment

### Table 1. PIN DESCRIPTION

FUNCTION
ECL Data Inputs ECL Data Outputs Positive Supply Negative Supply (DFN8 only) Thermal exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply (GND) or

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V <sub>CC</sub>	PECL Mode Power Supply	V <sub>EE</sub> = 0 V		8 to 0	V
$V_{EE}$	NECL Mode Power Supply	$V_{CC} = 0 V$		-8 to 0	V
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	$\begin{array}{c} V_{I} \! \leq \! V_{CC} \\ V_{I} \! \geq \! V_{EE} \end{array}$	6 to 0 -6 to 0	V V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	0 lfpm 500 lfpm	8 SOIC 8 SOIC	190 130	°C/W °C/W
$\theta_{\text{JC}}$	Thermal Resistance (Junction to Case)	Standard Board	8 SOIC	41 to 44 ± 5%	°C/W
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	0 lfpm 500 lfpm	8 TSSOP 8 TSSOP	185 140	°C/W °C/W
θJC	Thermal Resistance (Junction to Case)	Standard Board	8 TSSOP	41 to 44 ± 5%	°C/W
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	DFN8 DFN8	129 84	°C/W °C/W
T <sub>sol</sub>	Wave Solder Pb Pb-Free	<2 to 3 sec @ 248°C <2 to 3 sec @ 260°C		265 265	°C
θJC	Thermal Resistance (Junction to Case)	(Note 1)	DFN8	35 to 40	°C/W

Table 2. MAXIMUM RATINGS

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. JEDEC standard multilayer board - 2S2P (2 signal, 2 power)

#### Table 3. LVPECL DC CHARACTERISTICS V<sub>CC</sub> = 3.3 V; V<sub>EE</sub> = 0 V (Note 1)

			-40°C		25°C		85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		15	20		15	20		17	22	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	2215	2295	2420	2275	2345	2420	2275	2345	2420	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2)	1470	1605	1745	1490	1595	1680	1490	1595	1680	mV
V <sub>IH</sub>	Input HIGH Voltage	2135		2420	2135		2420	2135		2420	mV
V <sub>IL</sub>	Input LOW Voltage	1490		1825	1490		1825	1490		1825	mV
I <sub>IH</sub>	Input HIGH Current			150			150			150	μA
IIL	Input LOW Current	0.5			0.5			0.5			μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary  $\pm 0.3$  V.

2. Outputs are terminated through a 50  $\Omega$  resistor to V<sub>CC</sub> – 2.0 V.

#### Table 4. LVNECL DC CHARACTERISTICS V<sub>CC</sub> = 0 V; V<sub>EE</sub> = -3.3 V (Note 3)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		15	20		15	20		17	22	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 4)	-1085	-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V <sub>OL</sub>	Output LOW Voltage (Note 4)	-1830	-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV
VIH	Input HIGH Voltage	-1165		-880	-1165		-880	-1165		-880	mV
VIL	Input LOW Voltage	-1810		-1475	-1810		-1475	-1810		-1475	mV
IIH	Input HIGH Current			150			150			150	μA
IIL	Input LOW Current	0.5			0.5			0.5			μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary  $\pm 0.3$  V.

4. Outputs are terminated through a 50  $\Omega$  resistor to  $V_{CC}$ -2 volts.

#### Table 5. AC CHARACTERISTICS $V_{CC} = 3.3 \text{ V}$ ; $V_{EE} = 0 \text{ V}$ or $V_{CC} = 0 \text{ V}$ ; $V_{EE} = -3.3 \text{ V}$ (Note 5)

		-40°C		25°C		85°C					
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>max</sub>	Maximum Toggle Frequency		TBD			TBD			TBD		GHz
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay to Output	210	310	510	270	370	470	290	390	490	ps
t <sub>skew</sub>	Within Device Skew		40	100		40	100		40	100	ps
t <sub>JITTER</sub>	Cycle-to-Cycle Jitter		TBD			TBD			TBD		ps
t <sub>r</sub> t <sub>f</sub>	Output Rise/Fall Times Q (20% – 80%)	120	225	320	120	225	320	120	225	320	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5.  $V_{EE}$  can vary ±0.3 V.

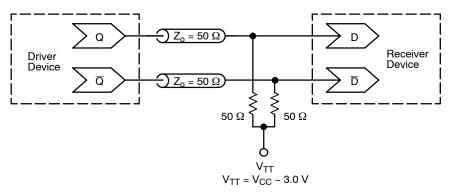


Figure 2. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>	
MC100LVEL01D	SOIC-8	98 Units / Rail	
MC100LVEL01DG	SOIC-8 (Pb-Free)	98 Units / Rail	
MC100LVEL01DR2	SOIC-8	2500 / Tape & Reel	
MC100LVEL01DR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel	
MC100LVEL01DT	TSSOP-8	100 Units / Rail	
MC100LVEL01DTG	TSSOP-8 (Pb-Free)	100 Units / Rail	
MC100LVEL01DTR2	TSSOP-8	2500 / Tape & Reel	
MC100LVEL01DTR2G	TSSOP-8 (Pb-Free)	2500 / Tape & Reel	
MC100LVEL01MNR4	DFN8	1000 / Tape & Reel	
MC100LVEL01MNR4G	DFN8 (Pb-Free)	1000 / Tape & Reel	

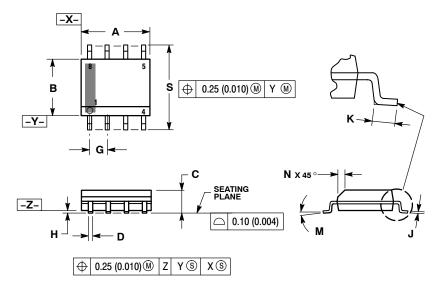
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **Resource Reference of Application Notes**

AN1405/D	_	ECL Clock Distribution Techniques
AN1406/D	-	Designing with PECL (ECL at +5.0 V)
AN1503/D	-	ECLinPS <sup>™</sup> I/O SPiCE Modeling Kit
AN1504/D	-	Metastability and the ECLinPS Family
AN1568/D	-	Interfacing Between LVDS and ECL
AN1672/D	-	The ECL Translator Guide
AND8001/D	-	Odd Number Counters Design
AND8002/D	-	Marking and Date Codes
AND8020/D	-	Termination of ECL Logic Devices
AND8066/D	-	Interfacing with ECLinPS
AND8090/D	-	AC Characteristics of ECL Devices

#### PACKAGE DIMENSIONS

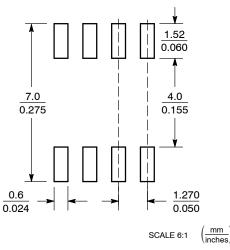
SOIC-8 NB CASE 751-07 **ISSUE AH** 

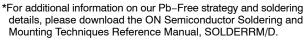


- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION. 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE. D DOGO NOT INCLUDE DAMPA
- 5. DIMENSION D DOES NOT INCLUDE DAMBAR
- PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.
- 6.

	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	4.80	5.00	0.189	0.197	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.053	0.069	
D	0.33	0.51	0.013	0.020	
G	1.27	7 BSC	0.050 BSC		
н	0.10	0.25	0.004	0.010	
J	0.19	0.25	0.007	0.010	
к	0.40	1.27	0.016	0.050	
М	0 °	8 °	0 °	8 °	
Ν	0.25	0.50	0.010	0.020	
S	5.80	6.20	0.228	0.244	

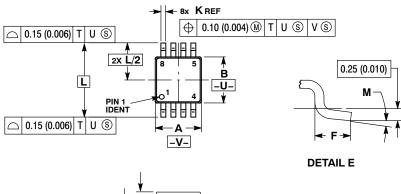
#### **SOLDERING FOOTPRINT\***

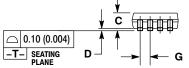


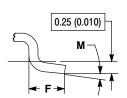


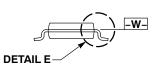
## PACKAGE DIMENSIONS

#### TSSOP-8 DT SUFFIX PLASTIC TSSOP PACKAGE CASE 948R-02 **ISSUE A**









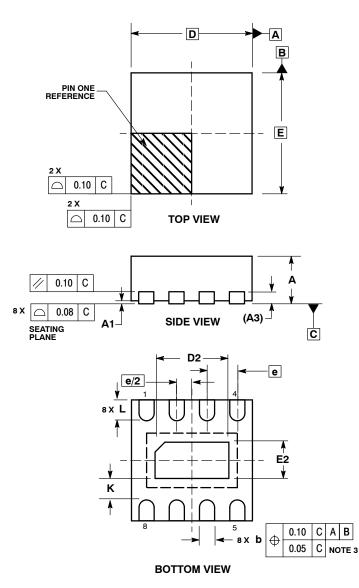
NOTES:
NOTES.
1. DIMENSIONING AND TOLERANCING PER ANSI
V1/ 5M 1082

- DIMENSIONED AND TOELINATION OF ET AND Y14.5M, 1982.
   CONTROLLING DIMENSION: MILLIMETER.
   DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH. OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
   DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
   TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
   DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	2.90	3.10	0.114	0.122	
В	2.90	3.10	0.114	0.122	
С	0.80	1.10	0.031	0.043	
D	0.05	0.15	0.002	0.006	
F	0.40	0.70	0.016	0.028	
G	0.65	BSC	0.026	BSC	
Κ	0.25	0.40	0.010	0.016	
L	4.90	BSC	0.193 BSC		
М	0°	6 °	0°	6°	

#### PACKAGE DIMENSIONS

DFN8 CASE 506AA-01 ISSUE D



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994 .
- 2. CONTROLLING DIMENSION: MILLIMETERS. 3. DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN
- 0.25 AND 0.30 MM FROM TERMINAL.
  4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS					
DIM	MIN	MAX				
Α	0.80	1.00				
A1	0.00	0.05				
A3	0.20 REF					
b	0.20	0.30				
D	2.00	BSC				
D2	1.10	1.30				
E	2.00	BSC				
E2	0.70	0.90				
е	0.50 BSC					
к	0.20					
L	0.25	0.35				

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